

U.S. Patent Application Serial No. 10/646,922  
Amendment filed February 8, 2006  
Reply to OA dated November 10, 2005

**AMENDMENTS TO THE CLAIMS:**

Claim 1-7 are pending in this application. Original claims 1 and 2 have been amended.

Claims 5-7 are new.

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

**Claim 1 (Currently Amended):** A foldable electronic device comprising

a main body (1), ~~and~~

a closure (2) ~~connected to each other openably,~~

a main display (4) ~~having a screen exposed from an inner surface of the closure (2),~~

a subdisplay (5) ~~having a screen exposed from a back surface of the closure (2),~~

a frame (6) ~~being provided inside the closure (2) and holding therein the main display (4) and~~

~~the subdisplay (5) as arranged back to back,~~

a chip mount area (42) of a flexible lead (41) extending from the main display (4), and

a chip mount area (53) of a flexible lead (51) extending from the subdisplay (5),

the main body and the closure being connected to each other openably, the main display

having a screen exposed from an inner surface of the closure (2), the subdisplay (5) having a screen

exposed from a back surface of the closure (2), the frame (6) being provided inside the closure (2)

and holding therein the main display (4) and the subdisplay (5) as arranged back to back, the chip

mount area (42) and the chip mount area (53) being opposed to each other in an opening formed in

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the frame (6), the opposed surfaces of the respective chip mount areas (42)(53) having groups of electronic circuit chips (43)(54) mounted thereon, the groups of electronic circuit chips (43)(54) beingas positioned in a staggered relation with each other,

wherein the groups of electronic circuit chips (43)(54) on the flexible leads (41)(51) are positioned in a staggered meshing relation with each other.

**Claim 2 (Currently Amended):** A foldable electronic device comprisingaccording to claim

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a main body (1),

a closure (2),

a main display (4),

a subdisplay (5),

a frame (6),

a chip mount area (42) of a flexible lead (41) extending from the main display (4), and

a chip mount area (53) of a flexible lead (51) extending from the subdisplay (5),

the main body and the closure being connected to each other openably, the main display having a screen exposed from an inner surface of the closure (2), the subdisplay (5) having a screen exposed from a back surface of the closure (2), the frame (6) being provided inside the closure (2) and holding therein the main display (4) and the subdisplay (5) as arranged back to back, the chip mount area (42) and the chip mount area (53) being opposed to each other in an opening formed in

the frame (6), the opposed surfaces of the respective chip mount areas (42)(53) having groups of electronic circuit chips (43)(54) mounted thereon, the groups of electronic circuit chips (43)(54) being positioned in a staggered relation with each other,

wherein the flexible lead (51) extending from the subdisplay (5) has an outer end portion folded over toward the frame (6) side, and the folded-over portion has a surface opposed to the frame (6) and providing the chip mount area (53).

**Claim 3 (Original):** A foldable electronic device according to claim 2 wherein the frame (6) has said opening in a second area thereof adjacent to a first area thereof covered with the subdisplay (5), and the flexible lead (51) extending from the subdisplay (5) is folded over on the second area, the electronic circuit chips (54) in the chip mount area (53) being positioned in said opening of the frame (6).

**Claim 4 (Original):** A foldable electronic device according to claim 3 wherein the flexible lead (41) extending from the main display (4) is folded over toward the frame (6) side, and the folded-over lead portion has a surface opposed to the frame (6) and providing the chip mount area (42), the electronic circuit chips (43) in the chip mount area (42) being positioned in said opening of the frame (6).

**Claim 5 (New):** A foldable electronic device according to claim 1 wherein the flexible lead (51) extending from the subdisplay (5) has an outer end portion folded over toward the frame (6) side, and the folded-over portion has a surface opposed to the frame (6) and providing the chip mount area (53).

**Claim 6 (New):** A foldable electronic device according to claim 5 wherein the frame (6) has said opening in a second area thereof adjacent to a first area thereof covered with the subdisplay (5), and the flexible lead (51) extending from the subdisplay (5) is folded over on the second area, the electronic circuit chips (54) in the chip mount area (53) being positioned in said opening of the frame (6).

**Claim 7 (New):** A foldable electronic device according to claim 6 wherein the flexible lead (41) extending from the main display (4) is folded over toward the frame (6) side, and the folded-over lead portion has a surface opposed to the frame (6) and providing the chip mount area (42), the electronic circuit chips (43) in the chip mount area (42) being positioned in said opening of the frame (6).